

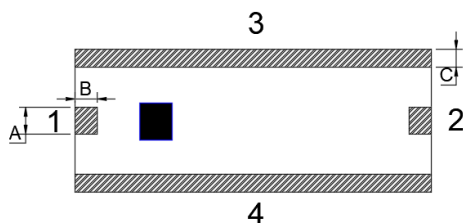
Features

- Multilayer monolithic construction yields high reliability
- Low insertion loss and small size SMD chip design
- Can simplify your complex tuning and circuit design
- LTCC process

Specifications

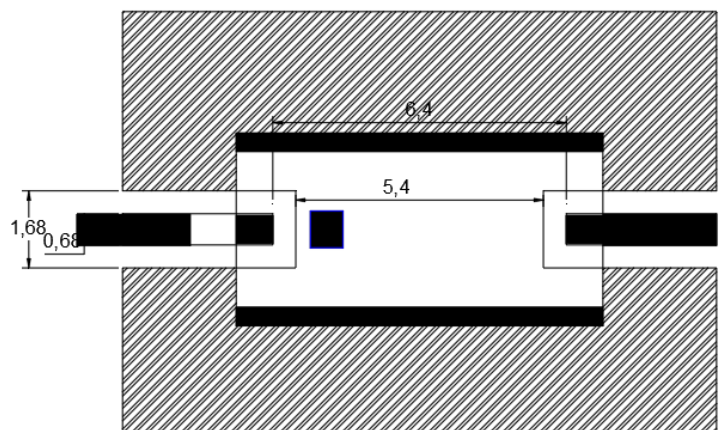
NO.	Parameter		SPEC
1	Frequency (MHz)		1400~2200
2	Insertion Loss (dB) @25℃		≤3.5
3	VSWR(In BW)		≤2.0
4	Ripple (dB)		≤2.0
5	Attenuation(dB)	0~1150MHz	≥45
		2800~3800MHz	≥45
		4000~6000MHz	TBD
6	Phase Consistency（8 pcs per group）		±5°
7	In/Output Impedance (Ω)		50
8	Power		5W
Operating & Storage Condition (Component)			
Operation Temperature Range: -40℃ ~ +85℃			
Storage Temperature Range: -40℃~ +85℃			
Storage Condition before Soldering (Included packaging material)			
Storage Temperature Range: +5 ~ +40 ℃			
Humidity: 30 to 70% relative humidity			

Construction



PIN	Connection
1	Input Port
2	Output Port
3	GND
4	GND

Mounting Considerations



Unit: mm

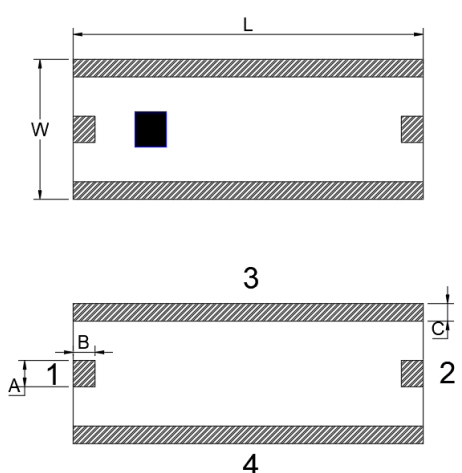
Yantel Corporation

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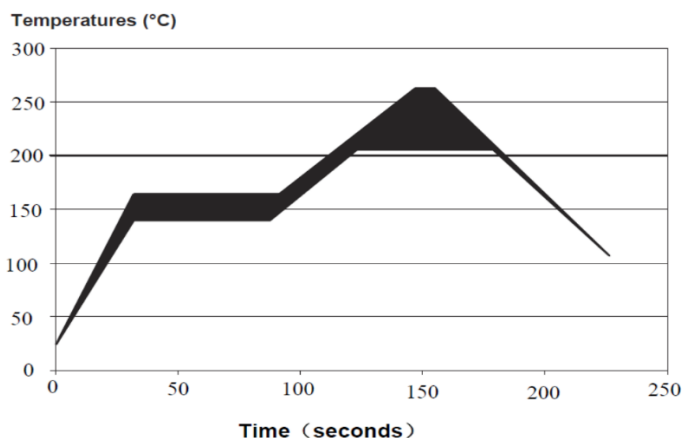
Tel: 86-755-8355-1886 Fax: 86-755-8355-2533

For detailed performance specs & shopping online see Yantel web site : www.yantel-corp.com

Dimensions

Figure	Symbol	Dimension (mm)
	L	8.00 ± 0.20
	W	4.20 ± 0.20
	T	2.00± 0.20
	A	0.60± 0.10
	B	0.50 ± 0.10
	C	0.40± 0.10

Solder Reflow Standard Conditioning



Storage Conditions

Temperature : +5 to +30 °C

Humidity : 20 to 70% RH

Term of storage : Within 12 months (After the delivery) *

Baking : Unnecessary

* After peeling off cover tape, do not keep exposing the products to the open air. For the products stored longer than 12 months, confirm their terminals and solderability before use.